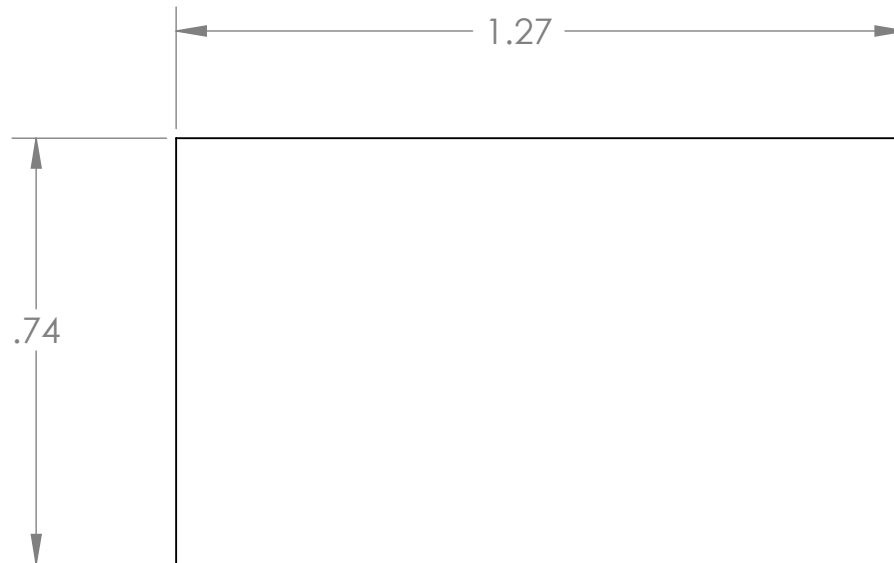



REV.	DESCRIPTION	DATE	APPROVED
1.0	Initial Release	06/14/2011	CMH



Label Material: Polyonics XF-781 White ESD Polyimide 1mil film, 1mil adh., 55# liner.

Packaging: Must be provided on a roll so they may be used on a thermal transfer printer.

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		CHECKED BY:		DATE:		PROJECT:	
		APPROVED BY:		DATE:		SIZE: A	
		DRAWING NO: 631-0009		REV: 1.0			
FILENAME: 631-0009-R1.0				SCALE: 1 TO 1			

	LS RESEARCH, LLC WIRELESS PRODUCT DEVELOPMENT W66 N220 COMMERCE COURT CEDARBURG, WI 53012 PHONE: (262) 375-4400 FAX: (262) 375-4248		

Model: COMAD400V3
FCC ID: XPB-COMAD400V3
IC: 8053B-COMAD400V3
LSR909YYWWXXXXXA
47545779-LF-A
450-0135-R3
FW VER: 2.4a



F105



TPRF

F106

F104

1

19

2

20

J2

Model: COMAD400V3
FCC ID: XPB-COMAD400V3
IC: 8053B-COMAD400V3
LSR910YYWWXXXXXA
47545786-LF-A
450-0136-R3
FW VER: 2.4a



FID5



FID6

FID4

